

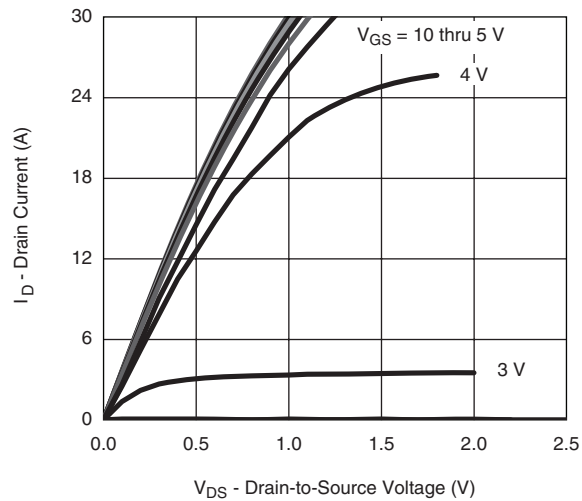
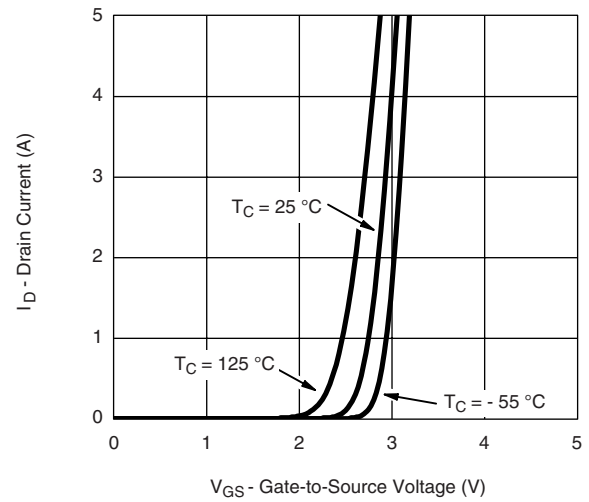
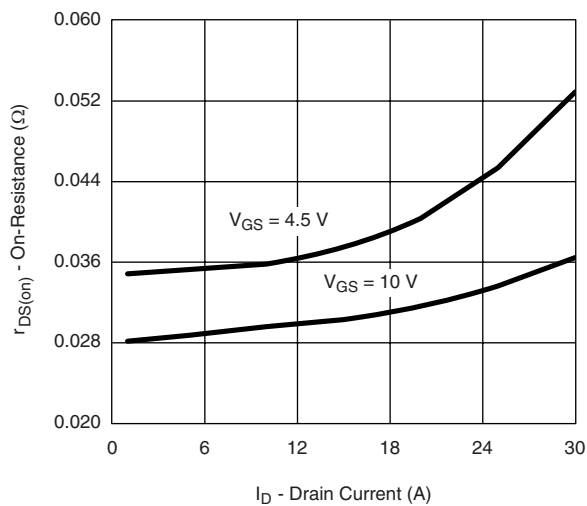
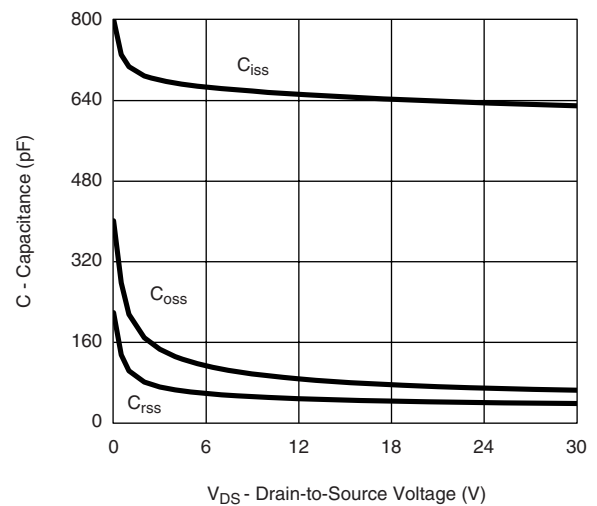
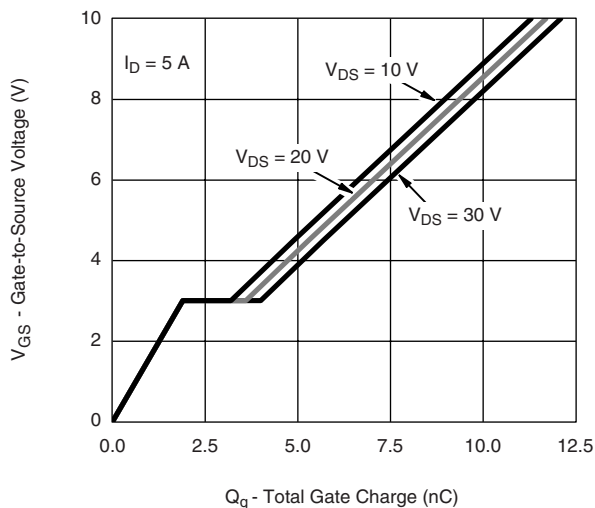
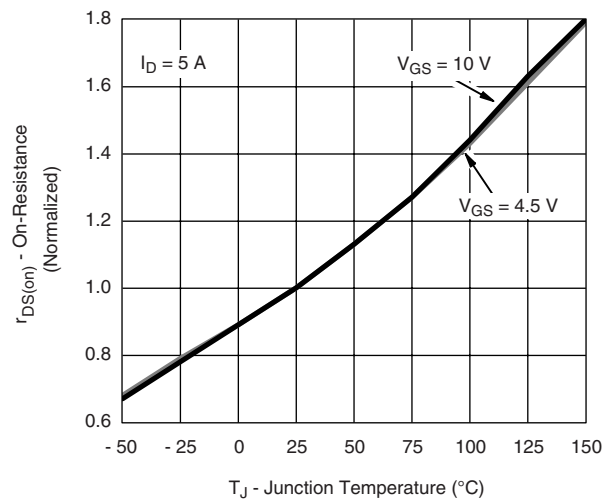
SPECIFICATIONS $T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}$, $I_D = 1\text{ mA}$	40			V	
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$		44		mV/ $^{\circ}\text{C}$	
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.5			
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	1.4		2.5	V	
Gate-Source Leakage	I_{GSS}	$V_{DS} = 0\text{ V}$, $V_{GS} = \pm 20\text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 40\text{ V}$, $V_{GS} = 0\text{ V}$			1	μA	
		$V_{DS} = 40\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 70\text{ }^{\circ}\text{C}$			20		
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}$, $V_{GS} = 10\text{ V}$	10			A	
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10\text{ V}$, $I_D = 5\text{ A}$		0.0305	0.037	Ω	
		$V_{GS} = 4.5\text{ V}$, $I_D = 4\text{ A}$		0.037	0.046		
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\text{ V}$, $I_D = 5\text{ A}$		22		S	
Dynamic ^b							
Input Capacitance	C_{iss}	$V_{DS} = 20\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1\text{ MHz}$		640		pF	
Output Capacitance	C_{oss}			73			
Reverse Transfer Capacitance	C_{rss}			41			
Total Gate Charge	Q_g	$V_{DS} = 20\text{ V}$, $V_{GS} = 10\text{ V}$, $I_D = 5\text{ A}$		11.7	20	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 20\text{ V}$, $V_{GS} = 4.5\text{ V}$, $I_D = 5\text{ A}$		5.3	9		
Gate-Drain Charge	Q_{gd}			1.9			
Gate Resistance	R_g			1.7			
Turn-On Delay Time	$t_{d(on)}$	$f = 1\text{ MHz}$		2.2		Ω	
Rise Time	t_r		$V_{DD} = 20\text{ V}$, $R_L = 4\text{ }\Omega$ $I_D \equiv 5\text{ A}$, $V_{GEN} = 4.5\text{ V}$, $R_g = 1\text{ }\Omega$		18	30	ns
Turn-Off Delay Time	$t_{d(off)}$				14	25	
Fall Time	t_f				14	25	
Turn-On Delay Time	$t_{d(on)}$			10	20		
Rise Time	t_r	$V_{DD} = 20\text{ V}$, $R_L = 4\text{ }\Omega$ $I_D \equiv 5\text{ A}$, $V_{GEN} = 10\text{ V}$, $R_g = 1\text{ }\Omega$		9	18		
Turn-Off Delay Time	$t_{d(off)}$			11	20		
Fall Time	t_f			14	25		
				8	18		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	$T_C = 25\text{ }^{\circ}\text{C}$			8	A	
Pulse Diode Forward Current ^a	I_{SM}				30		
Body Diode Voltage	V_{SD}	$I_S = 2\text{ A}$		0.805	1.2	V	
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 2\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, $T_J = 25\text{ }^{\circ}\text{C}$		19	30	ns	
Body Diode Reverse Recovery Charge	Q_{rr}			14	25	nC	
Reverse Recovery Fall Time	t_a			13		ns	
Reverse Recovery Rise Time	t_b			6			

Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

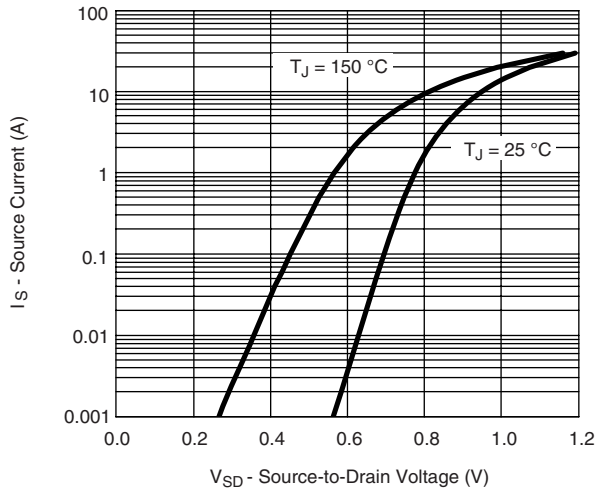
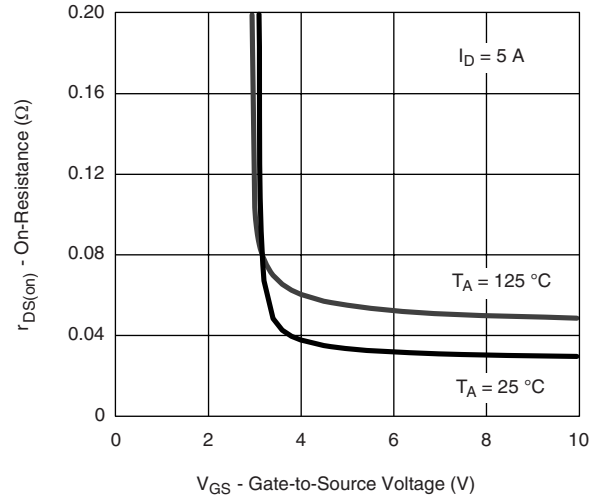
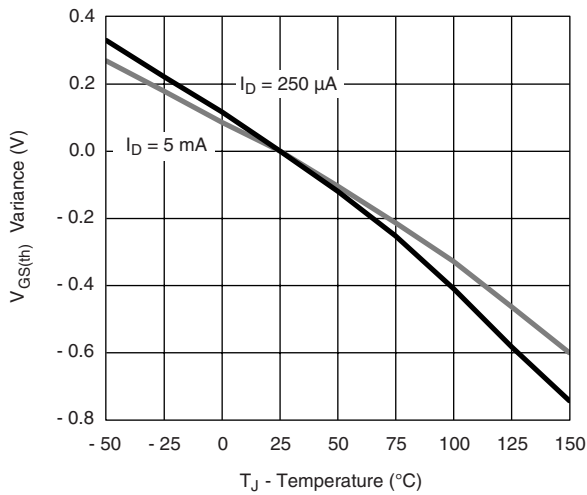
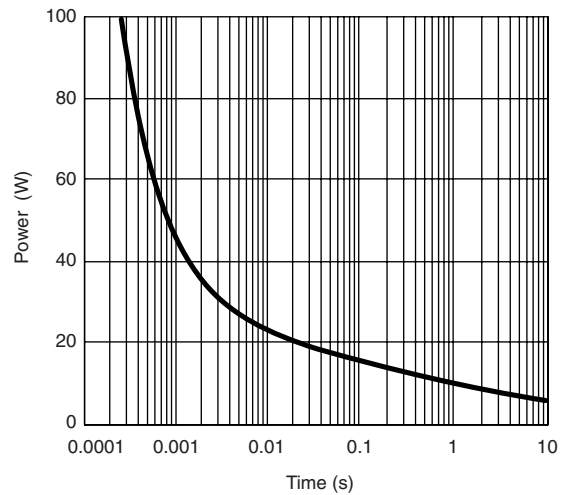
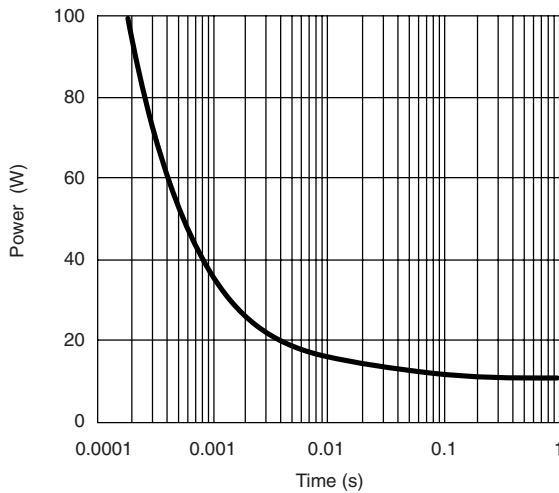
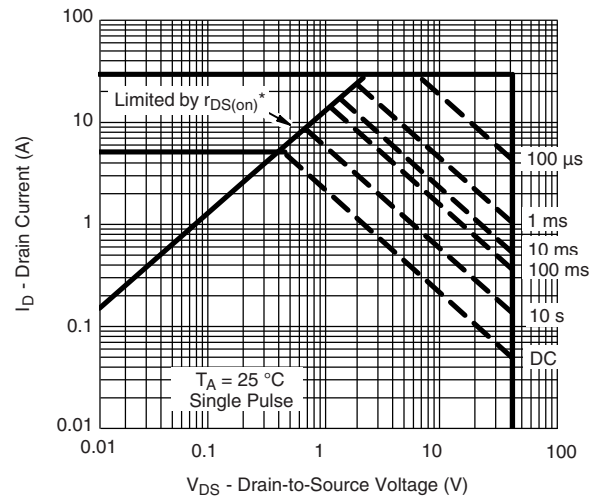
b. Guaranteed by design, not subject to production testing.

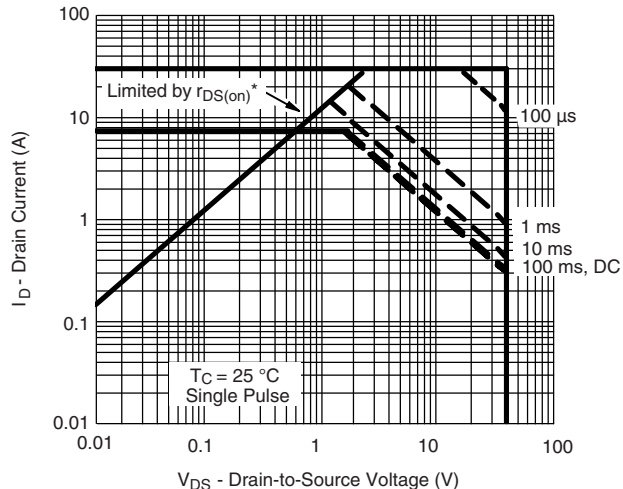
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Output Characteristics****Transfer Characteristics****On-Resistance vs. Drain Current****Capacitance****Gate Charge****On-Resistance vs. Junction Temperature**

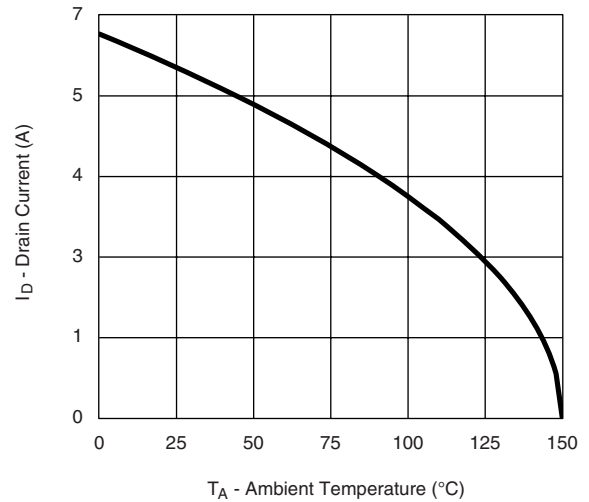
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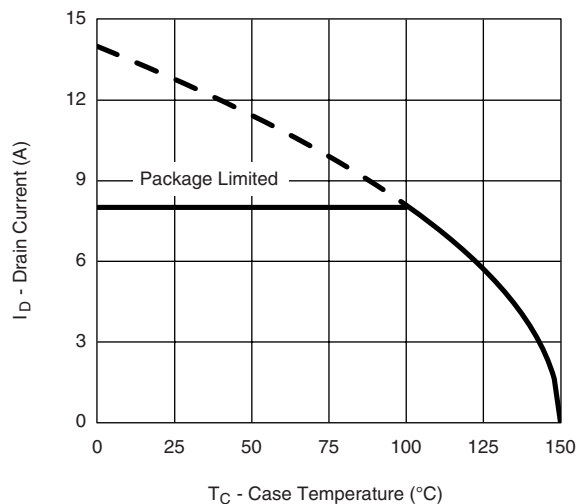
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power, Junction-to-Ambient****Single Pulse Power, Junction-to-Case*** $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified**Safe Operating Area, Junction-to-Ambient**

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

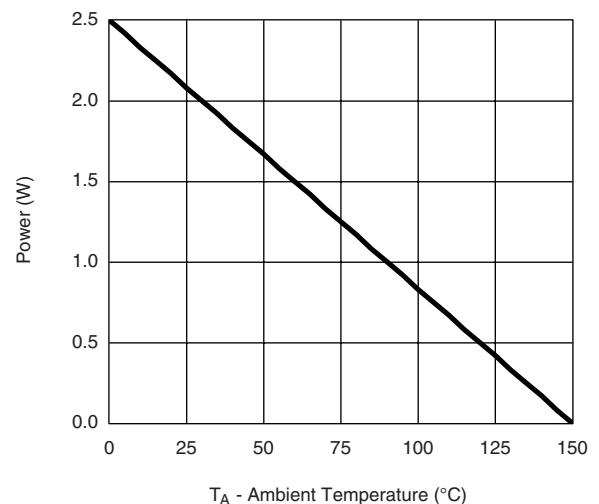
V_{DS} - Drain-to-Source Voltage (V)
* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Case



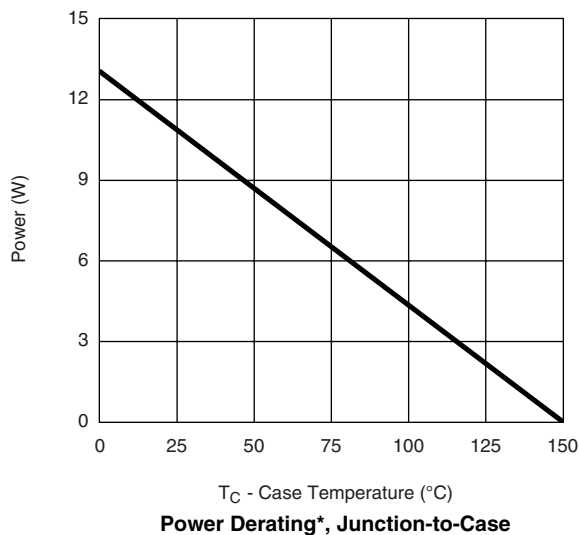
T_A - Ambient Temperature ($^\circ\text{C}$)
Current Derating*, Junction-to-Ambient



T_C - Case Temperature ($^\circ\text{C}$)
Current Derating*, Junction-to-Case



T_A - Ambient Temperature ($^\circ\text{C}$)
Power Derating*, Junction-to-Ambient

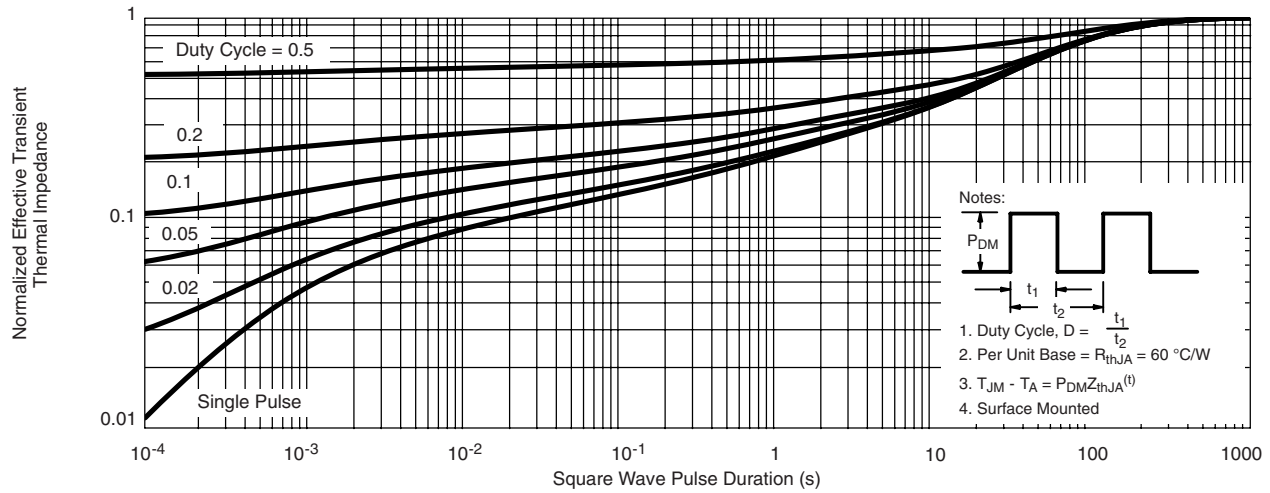
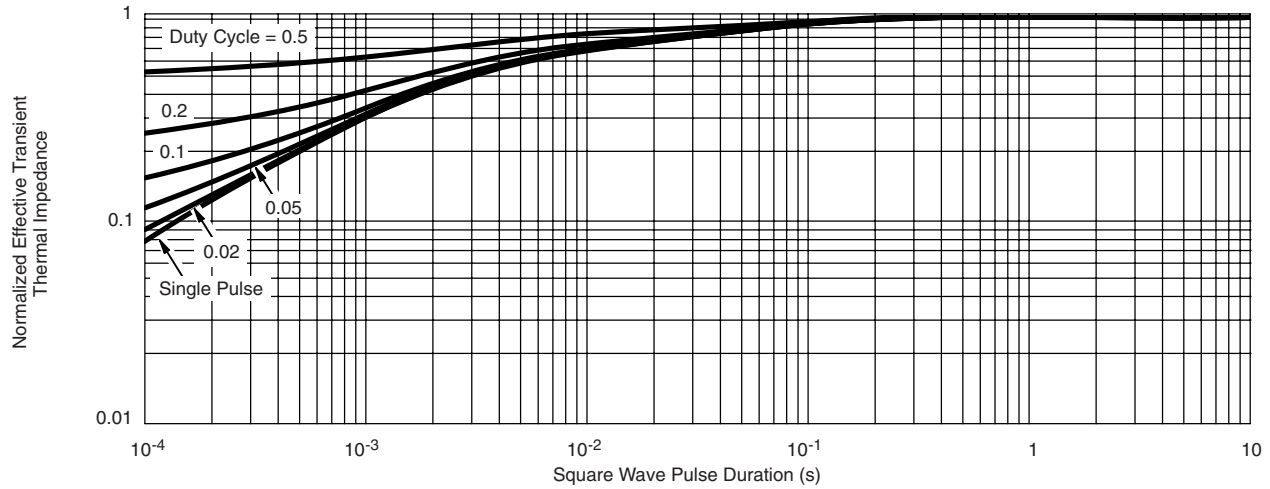


T_C - Case Temperature ($^\circ\text{C}$)
Power Derating*, Junction-to-Case

* The power dissipation P_D is based on $T_{J(max)} = 175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Case**

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